g		GE Energy	Fu	nctional T	esting Spe	ecification	
Parts & Repair Services Louisville, KY				LOU-GED-193X252AAG02			
		Test Procedure	o for a 193X252AAG02	2 Card			
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#### 1. SCOPE

**1.1** This is a functional testing procedure for a 193X252AAG02 Card.

### 2. STANDARDS OF QUALITY

**2.1** Refer to the current revision of the IPC-A-610 standard for workmanship standards.

### 3. APPLICABLE DOCUMENTS

- **3.1** The following document(s) shall form part of this specification to the extent specified herein. Unless otherwise indicated, the latest issue shall apply.
  - 3.1.1 Test Instruction 224X697AB
  - 3.1.2 Engineering Spec 224X250AA

### 4. ENGINEERING REQUIREMENTS

- **4.1** Equipment Cleaning
  - **4.1.1** Equipment should be clean and free of debris prior to applying power unless performing an initial check. Refer to the local documented procedures for cleaning guidelines.
- **4.2** Equipment Inspection
  - **4.2.1** Equipment should be visually inspected for any defects prior to applying power. This inspection should include the following as a minimum:
    - **4.2.1.1** Wires broken, cracked, or loosely connected
    - 4.2.1.2 Terminal strips / connectors broken or cracked
    - **4.2.1.3** Components visually damaged
    - 4.2.1.4 Capacitors bloated or leaking
    - 4.2.1.5 Solder joints damaged or cold
    - 4.2.1.6 Circuit board burned or de-laminated
    - 4.2.1.7 Printed wire runs / Traces burned or damaged

### 5. EQUIPMENT REQUIRED

**5.1** The following equipment is required to perform the process requirements. Equipment may be substituted provided that all accuracy's and test ratios are equivalent or better.

Qty	Reference #	Description
1		Fluke 87 DMM (or Equivalent)
1		Variable Power Supply +5VDC
1		Oscilloscope

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#### 6. TESTING PROCESS

- 6.1 Setup
  - **6.1.1** With a DVM in the diode check mode static check diodes using the following procedure.
    - 6.1.1.1 Forward Bias
      - **6.1.1.1.1** (-) to Pin 29 & (+) to pins 23 thru 28.
      - **6.1.1.1.2** (+) to Pin 22 & (-) to pins 23 thru 28.
    - 6.1.1.2 Reverse Bias
      - **6.1.1.2.1** (+) to pin 29 & (-) to pins 23 thru 28.
      - **6.1.1.2.2** (-) to Pin 22 & (+) to pins 23 thru 28.

### 6.2 Testing Procedure

### 6.2.1 30 Volt Power Supplies

- **6.2.1.1** Apply +30 VDC to pin 29 and -30VDC to pin 22 and common to pin 15.
- **6.2.1.2** Pin 31 should measure between +19.6 to +20.4VDC with no load applied.
- 6.2.1.3 Pin 2 should measure between -19.6 to -20.4VDC with no load applied.

### 6.2.2 20 Volt Power Supplies

**6.2.2.1** Apply a 165 ohm load to the +- 20VDC supplies and the output voltage should sag less then .01VDC

### 6.2.3 Regulator

**6.2.3.1** Apply 5VDC to tab 13 through a 6.81K 1% resistor. The regulator output, tab 6, should be 7.42VDC, (+-.12VDC). The first stage output should rest at 0.00 volts, pin 11.

#### 6.2.4 FET Switch

- **6.2.4.1** With 5VDC applied as in the previous step, short tab 16 to common. Tab 11 should go to -12VDC min on pin 6. Tab 6 should go to between +8.3VDC and +8.8VDC.
- **6.2.4.2** Now apply -5VDC to tab 13 as above. Tab 11 should go to +12VDC min on a G02. Tab 6 should go to between -8.3VDC and -8.8VDC.

### 6.2.5 Feedback

- **6.2.5.1** With -5VDC applied as in previous step, apply a +6VDC signal to tab 18; tab 6 should go to -7.42VDC (+-.12VDC).
- **6.2.5.2** Remove the +6VDC from tab 18 and place a 6.8K-ohm 1% resistor between tab 3 & 14, tab 6 should go to between -4.85VDC and -5.15VDC.

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## 6.2.6 Auxiliary Amplifier

6.2.6.1 Place a 10K ohm 1% resistor between tabs 8 & 9 and a 10K ohm 1% resistor from 9 to common. Place -5VDC on tab 10. Tab 8 should go to -10VDC (+-0.2VDC. Disconnect pin 10. Apply a -10VDC at tab 13 6.8K ohm 1% resistor. Pin 11 should measure a minimum of +12VDC.

## **6.3** \*\*\*TEST COMPLETE \*\*\*

### 7. NOTES

**7.1** None at this time.